

Initial Product/Process Change Notification Document #: IPCN20912X

Issue Date: 9 June 2015

Title of Change:	Adding King Yuan Electronics Corp Taiwan (KYEC) as an additional Final Test Location		
Proposed first ship date:	15 October 2015 or Earlier upon customer approval.		
Contact information:	ntact information: Contact your local ON Semiconductor Sales Office or Tamara Olney <tamara.olney@onsemi.com></tamara.olney@onsemi.com>		
Samples:	Contact your local ON Semiconductor Sales Office.		
Type of notification:	This is an Initial Product/Process Change Notification (IPCN) sent to customers. IPCNs are issued at least 120 days prior to implementation of the change. An IPCN is advance notification about an upcoming change and contains general information regarding the change details and devices affected. It also contains the preliminary reliability qualification plan. The completed qualification and characterization data will be included in the Final Product/Process Change Notification (FPCN). This IPCN notification will be followed by a Final Product/Process Change Notification (FPCN) at least 90 days prior to implementation of the change. In case of questions, contact <pcn.support@onsemi.com>.</pcn.support@onsemi.com>		
Change category(s): Wafer Fab Change Assembly Change Test Change		✓ Manufacturing Site Change/Addition✓ Manufacturing Process Change✓ Material Change	☐ Product specific change ☐ Datasheet/Product Doc change ☐ Shipping/Packaging/Marking ☐ Other:
Sites Affected: ☐ All site(s) ☐ not applicable ☐ ON Semiconductor site(s): ☑ External Foundry/Subcon site(s):		<u>Site 1</u>	Site 2 King Yuan Electronics Co., Ltd.
Description and Purpose: Adding KYEC as an additional test site to increase ON Semiconductor test capacity. This change does not affect the product form, fit, or function. KYEC is a qualified test house for ON Semiconductor.			
Qualification Plan: Estimated date for qualification completion: 3 July 2015 Qualification will be per ON Semiconductor 12MID07-0107. This includes repeatability tests, correlation of parametric measurements, and			
yield/bin correlation.			
Full parametric correlation will be performed and for every test the shift will be evaluated as follows:			
dmean = abs(mean(ref)-mean(qual))			
dsigma = 0			if sigma(qual) < sigma(ref)
dsigma = sigma(qual) – sigma(ref)			if sigma(qual) > sigma(ref)
shift = dmean + 4 * dsigma			
If shift < max(5% specwidth, 6*sigma(ref)) then correlation is OK for this test,			else correlation is NOK for this test
Any parameter that exceeds the allowable shift is independently analysed and explained			

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List of Affected Standard Parts:

NCP1090DRG

NCP1090DG

SCY4001DG

NCN5120MNTWG

AMIS30543C5431RG

NCP1092DG

NCP1092DRG

NCN5193MNTWG

NCS37013MNTWG

NCS37010DBRG

NOTE: Please be informed that parts impacted by this PDN/PCN are Special/Customer specific parts, thus MPN & CPN info will be available to affected customers only by clicking the "Custom PCN for Selected Company Button" in the Document Analysis page of PCMS/PCN Alert.

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